

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENTS

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Examiner: Ron E. Pompey

Serial No: 10/029,512

Art Unit: 2812

Filed: December 21, 2001

Docket: BUR919990120US2 (13344A)

For: PROCESS USING POLY-BUFFERED STI **Dated:** January 24, 2003

Assistant Commissioner for Patents
United States Patent and Trademark Office
Washington, D.C. 20231

LETTER TO THE OFFICIAL DRAFTSMAN

Sir:

Enclosed herewith is a photocopy of the informal drawings for the above referenced application containing proposed revisions hereto in red ink. Specifically, in FIG. 2E reference number 115 has been added to indicate the rounded corners of the conformal oxide layer, and reference lines 112 have been extended to more clearly indicate the conformal oxide layer.

The filing of formal drawings with the above corrections therein will be made when approval of the foregoing amendment has been indicated.

Respectfully submitted,

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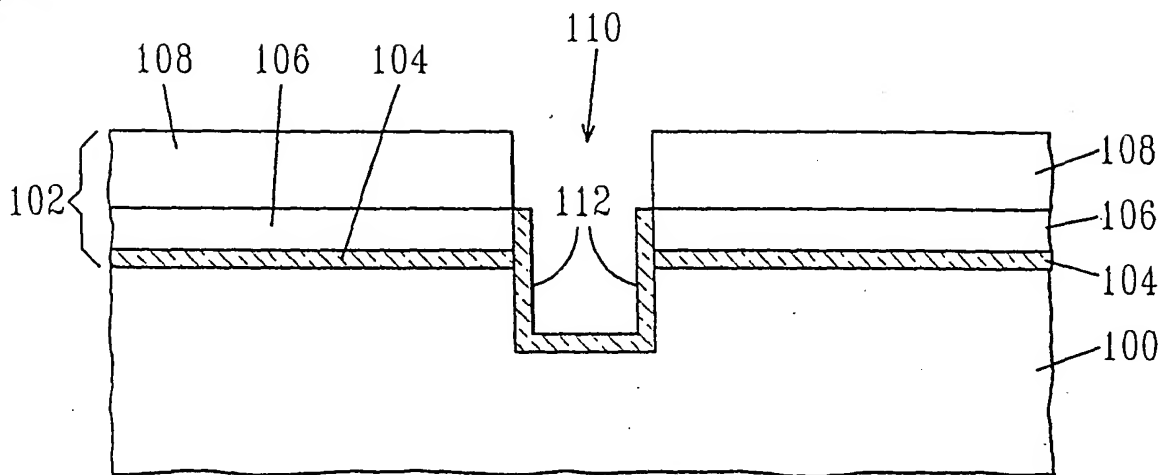


FIG. 2C

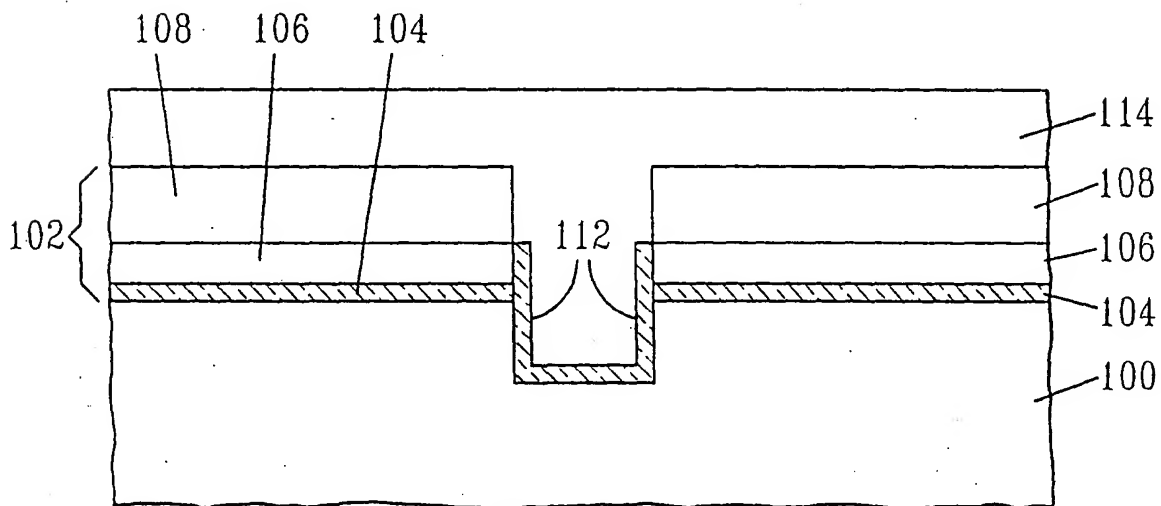


FIG. 2D

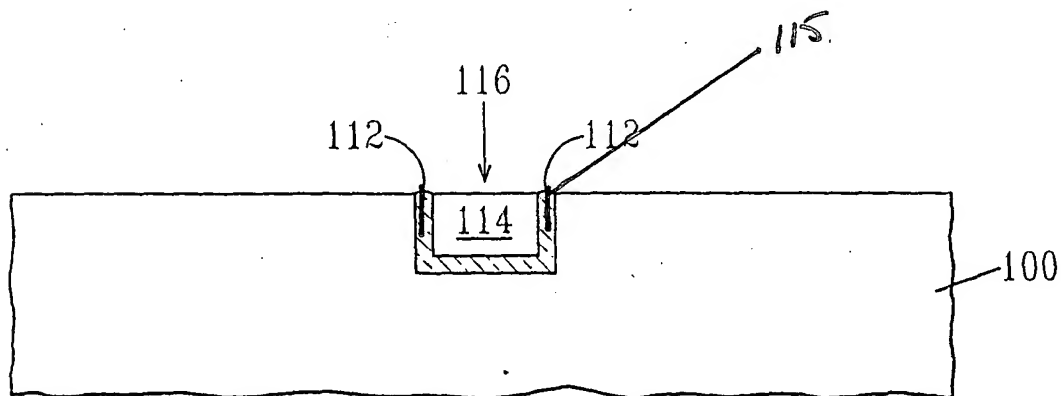


FIG. 2E